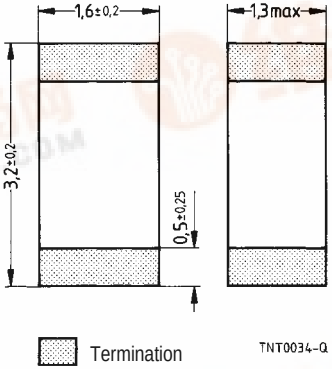
查询B57621C102J62供应商 捷多邦，专业PCB打样工厂，24小时加急出货

Applications

- Temperature compensation
- Hybrid circuits
- Data systems
- Telecom systems
- Automotive electronics
- LC displays

Features

- Small dimensions, EIA size 1206
- Silver palladium terminations
- Cost-effective
- Suitable for automatic placement
- Suitable for wave and reflow soldering
- Available on tape (PU: 4000 pcs)



Dimensions in mm
Approx. weight 18 mg

Options

Alternative resistance ratings and resistance tolerance < 5% available on request

Climatic category (IEC 68-1)		55/125/21	
Max. power at 25 °C (on PCB)	P_{25}	300	mW
Resistance tolerance	$\Delta R/R_N$	± 5 %, ± 10 %, ± 20 %	
Rated temperature	T_N	25	°C
B value tolerance	$\Delta B/B$	± 3 %	
Dissipation factor (on PCB)	δ_{th} 1)	approx. 5	mW/K
Thermal cooling time constant (on PCB)	τ_c 1)	approx. 10	s
Heat capacity	C_{th} 1)	approx. 50	mJ/K

Type	R_{25} Ω	No. of R/T characteristic	$B_{25/100}$ K	Ordering code
C 621/2,2 k/+	2,2 k	1308	3060	B57621-C222-+62
C 621/3,3 k/+	3,3 k	1309	3520	B57621-C332-+62
C 621/4,7 k/+	4,7 k	1309	3520	B57621-C472-+62
C 621/10 k/+	10 k	1010	3530	B57621-C103-+62
C 621/15 k/+	15 k	1008	3560	B57621-C153-+62
C 621/22 k/+	22 k	1008	3560	B57621-C223-+62
C 621/33 k/+	33 k	2003	3980	B57621-C333-+62
C 621/47 k/+	47 k	2001	3920	B57621-C473-+62
C 621/68 k/+	68 k	2001	3920	B57621-C683-+62

+: J for $\Delta R/R_N$ = ± 5 %
K for $\Delta R/R_N$ = ± 10 %
M for $\Delta R/R_N$ = ± 20 %

1)

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Type	R_{25} Ω	No. of R/T characteristic	$B_{25/100}$ K	Ordering code
C 621/100 k/+	100 k	4901	3950	B57621-C104-+62
C 621/150 k/+	150 k	2903	4200	B57621-C154-+162
C 621/220 k/+	220 k	2903	4200	B57621-C224-+62
C 621/330 k/+	330 k	1014	4250	B57621-C334-+62
C 621/470 k/+	470 k	1014	4250	B57621-C474-+62

+: J for $\Delta R/R_N = \pm$ 5 %
K for $\Delta R/R_N = \pm$ 10 %
M for $\Delta R/R_N = \pm$ 20 %

Reliability data

Tested on standardized PCB in accordance with IEC 60068-2-21

Test	Standard	Test conditions	$\Delta R_{25}/R_{25}$ (typical)	Remarks
Storage in dry heat	IEC 60068-2-2	Storage at upper category temperature *T*: 125 °C *t*: 1000 h	< 3 %	
Storage in damp heat, steady state	IEC 60068-2-3	Temperature of air: 40 °C Relative humidity of air: 93 % Duration: 21 days	< 3 %	No visible damage
Rapid temperature cycling	IEC 60068-2-14	Lower test temperature: – 55 °C Upper test temperature: 125 °C Number of cycles: 10	< 3 %	
Endurance		P_{max}: 300 mW Duration: 1000 h	< 5 %	
Solderability	IEC 60068-2-58	Solderability: 215 °C/4 s 235 °C/2 s Resistance to soldering heat: 260 °C/10 s	< 3 %	95 % of terminations wetted
Robustness of terminations		Bending of carrier (2 mm bending) Refer also to page 120	< 3 %	No visible damage